## NPN Silicon RF Transistor

- For low current applications
- For oscillators up to 12 GHz
- Noise figure $F=1.25 \mathrm{~dB}$ at 1.8 GHz
outstanding $G_{\mathrm{ms}}=23 \mathrm{~dB}$ at 1.8 GHz
- SIEGET ${ }^{\circledR} 25 \mathrm{GHz}$ fT - Line

- Pb-free (RoHS compliant) package
- Qualified according AEC Q101


ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Type | Marking | Pin Configuration |  |  |  |  | Package |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| BFP405 | ALs | $1=\mathrm{B}$ | $2=\mathrm{E}$ | $3=\mathrm{C}$ | $4=\mathrm{E}$ | - | - | SOT343 |

Maximum Ratings

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :---: | :--- |
| Collector-emitter voltage | $V_{\mathrm{CEO}}$ |  | V |
| $T_{\mathrm{A}}>0^{\circ} \mathrm{C}$ |  | 4.5 |  |
| $T_{\mathrm{A}} \leq 0^{\circ} \mathrm{C}$ |  | 4.1 |  |
| Collector-emitter voltage | $V_{\mathrm{CES}}$ | 15 |  |
| Collector-base voltage | $V_{\mathrm{CBO}}$ | 15 |  |
| Emitter-base voltage | $V_{\mathrm{EBO}}$ | 1.5 |  |
| Collector current | $I_{\mathrm{C}}$ | 25 | mA |
| Base current | $I_{\mathrm{B}}$ | 1 |  |
| Total power dissipation ${ }^{1)}$ | $P_{\text {tot }}$ | 75 | mW |
| $T_{\mathrm{S}} \leq 108^{\circ} \mathrm{C}$ | $T_{\mathrm{J}}$ |  |  |
| Junction temperature | $T_{\mathrm{A}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Ambient temperature | $T_{\text {Stg }}$ | $-65 \ldots 150$ |  |
| Storage temperature | $-65 \ldots 150$ |  |  |

[^0]
## Thermal Resistance

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :--- | :--- |
| Junction - soldering point 1 ) | $R_{\text {thJS }}$ | $\leq 555$ | K/W |

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| DC Characteristics | $V_{(B R) C E O}$ | 4.5 | 5 | - | V |
| Collector-emitter breakdown voltage <br> $I_{\mathrm{C}}=1 \mathrm{~mA}, I_{\mathrm{B}}=0$ | $I_{\mathrm{CES}}$ | - | - | 10 | $\mu \mathrm{~A}$ |
| Collector-emitter cutoff current <br> $V_{\mathrm{CE}}=15 \mathrm{~V}, V_{\mathrm{BE}}=0$ | $I_{\mathrm{CBO}}$ | - | - | 100 | nA |
| Collector-base cutoff current <br> $V_{\mathrm{CB}}=5 \mathrm{~V}, I_{\mathrm{E}}=0$ | $I_{\mathrm{EBO}}$ | - | - | 1 | $\mu \mathrm{~A}$ |
| Emitter-base cutoff current <br> $V_{\mathrm{EB}}=0.5 \mathrm{~V}, I_{\mathrm{C}}=0$ | $h_{\mathrm{FE}}$ | 60 | 95 | 130 | - |
| DC current gain |  |  |  |  |  |
| $I_{\mathrm{C}}=5 \mathrm{~mA}, V_{\mathrm{CE}}=4 \mathrm{~V}$, pulse measured |  |  |  |  |  |

[^1]BFP405

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :--- | :---: | :---: | :---: | :---: | :--- |
|  |  | min. | typ. | max. |  |

AC Characteristics (verified by random sampling)

| Transition frequency $I_{\mathrm{C}}=10 \mathrm{~mA}, V_{\mathrm{CE}}=3 \mathrm{~V}, f=2 \mathrm{GHz}$ | $f_{\text {T }}$ | 18 | 25 | - | GHz |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-base capacitance $V_{\mathrm{CB}}=2 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{BE}}=0,$ <br> emitter grounded | $C_{\text {cb }}$ | - | 0.05 | 0.1 | pF |
| Collector emitter capacitance $V_{\mathrm{CE}}=2 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{BE}}=0$ <br> base grounded | $C_{c e}$ | - | 0.24 | - |  |
| Emitter-base capacitance $V_{\mathrm{EB}}=0.5 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{CB}}=0$ <br> collector grounded | $C_{\text {eb }}$ | - | 0.29 | - |  |
| Noise figure $I_{\mathrm{C}}=2 \mathrm{~mA}, V_{\mathrm{CE}}=2 \mathrm{~V}, f=1.8 \mathrm{GHz}, Z_{\mathrm{S}}=Z_{\mathrm{Sopt}}$ | F | - | 1.25 | - | dB |
| Power gain, maximum stable ${ }^{1)}$ $\begin{aligned} & I_{\mathrm{C}}=5 \mathrm{~mA}, V_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{Sopt}}, \\ & Z_{\mathrm{L}}=Z_{\text {Lopt }}, f=1.8 \mathrm{GHz} \end{aligned}$ | $G_{\mathrm{ms}}$ | - | 23 | - | dB |
| Insertion power gain $\begin{aligned} & V_{\mathrm{CE}}=2 \mathrm{~V}, I_{\mathrm{C}}=5 \mathrm{~mA}, f=1.8 \mathrm{GHz}, \\ & \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega \end{aligned}$ | $\left\|S_{21}\right\|^{2}$ | 14 | 18.5 | - |  |
| Third order intercept point at output ${ }^{2}$ ) $\begin{aligned} & V_{\mathrm{CE}}=2 \mathrm{~V}, I_{\mathrm{C}}=5 \mathrm{~mA}, f=1.8 \mathrm{GHz}, \\ & Z_{\mathrm{S}}=Z_{\mathrm{L}}=50 \Omega \end{aligned}$ | $I P_{3}$ | - | 15 | - | dBm |
| 1 dB Compression point at output $\begin{aligned} & I_{\mathrm{C}}=5 \mathrm{~mA}, V_{\mathrm{CE}}=2 \mathrm{~V}, \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega, \\ & f=1.8 \mathrm{GHz} \end{aligned}$ | $P_{-1 \mathrm{~dB}}$ | - | 5 | - |  |

${ }^{1} G_{\mathrm{ms}}=\left|S_{21} / S_{12}\right|$
${ }^{2}$ IP3 value depends on termination of all intermodulation frequency components.
Termination used for this measurement is $50 \Omega$ from 0.1 MHz to 6 GHz

## Simulation Data

For SPICE-model as well as for S-parameters including noise parameters refer to our internet website: www.infineon.com/rf.models. Please consult our website and download the latest version before actually starting your design.
The simulation data have been generated and verified up to 12 GHz using typical devices. The BFP405 nonlinear SPICE-model reflects the typical DC- and RF-device performance with high accuracy.

Total power dissipation $P_{\text {tot }}=f\left(T_{\mathrm{S}}\right)$


Permissible Pulse Load
$P_{\text {totmax }} / P_{\text {totDC }}=f\left(t_{\mathrm{p}}\right)$


Permissible Pulse Load $R_{\text {th } J S}=f\left(t_{\mathrm{p}}\right)$


Collector-base capacitance $C_{c b}=f\left(V_{C B}\right)$ $f=1 \mathrm{MHz}$


Transition frequency $f_{\mathrm{T}}=f\left(I_{\mathrm{C}}\right)$
$f=2 \mathrm{GHz}$
$V_{C E}=$ parameter in $V$


Power gain $G_{m a}, G_{m s}=f\left(I_{\mathrm{C}}\right)$
$V_{C E}=3 V$
$f=$ parameter in GHz


Power gain $G_{\mathrm{ma}}, G_{\mathrm{ms}},\left|S_{21}\right|^{2}=f(f)$
$V_{C E}=3 \mathrm{~V}, I_{C}=5 \mathrm{~mA}$


Power gain $G_{m a}, G_{m s}=f\left(V_{C E}\right)$
$I_{C}=5 \mathrm{~mA}$
$f=$ parameter in GHz


Noise figure $F=f\left(I_{C}\right)$
$V_{\text {CE }}=2 \mathrm{~V}, Z_{\mathrm{S}}=Z_{\text {Sopt }}$


Noise figure $F=f(f)$
$V_{C E}=1 \mathrm{~V}, Z_{S}=Z_{\text {Sopt }}$


Noise figure $F=f\left(I_{C}\right)$
$V_{C E}=2 \mathrm{~V}, f=1.8 \mathrm{GHz}$


Source impedance for min.
noise figure vs. frequency

$$
V_{\mathrm{CE}}=3 \mathrm{~V}, I_{\mathrm{C}}=2 \mathrm{~mA} / 5 \mathrm{~mA}
$$



Package Outline


Foot Print


Marking Layout (Example)


## Standard Packing

Reel $\varnothing 180 \mathrm{~mm}=3.000$ Pieces/Reel
Reel $\varnothing 330 \mathrm{~mm}=10.000$ Pieces/Reel


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[^0]:    ${ }^{1} T_{\mathrm{S}}$ is measured on the collector lead at the soldering point to the pcb

[^1]:    ${ }^{1}$ For calculation of $R_{\text {thJA }}$ please refer to Application Note Thermal Resistance

